

SEMiX302GAL17E4s



SEMiX® 2s

SEMiX302GAL17E4s

Features

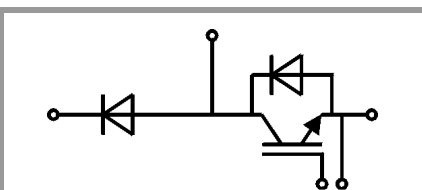
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- UL recognized, file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic Welding

Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j=150^\circ\text{C}$
- Dynamic values apply to the following combination of resistors:
 $R_{Gon,main} = 1,95 \Omega$
 $R_{Goff,main} = 1,95 \Omega$
 $R_{G,X} = 2,2 \Omega$
 $R_{E,X} = 0,5 \Omega$



GAL

| Absolute Maximum Ratings | | | | |
|---------------------------|--|---------------------------|------------------|---------------|
| Symbol | Conditions | Values | Unit | |
| IGBT | | | | |
| V_{CES} | $T_j = 25^\circ\text{C}$ | 1700 | V | |
| I_C | $T_j = 175^\circ\text{C}$ | $T_c = 25^\circ\text{C}$ | 516 | A |
| | | $T_c = 80^\circ\text{C}$ | 392 | A |
| I_{Cnom} | | 300 | A | |
| I_{CRM} | $I_{CRM} = 3 \times I_{Cnom}$ | 900 | A | |
| V_{GES} | | -20 ... 20 | V | |
| t_{psc} | $V_{CC} = 1000 \text{ V}$ $V_{GE} \leq 15 \text{ V}$ $V_{CES} \leq 1700 \text{ V}$ | $T_j = 150^\circ\text{C}$ | 10 | μs |
| | | | | |
| T_j | | -40 ... 175 | $^\circ\text{C}$ | |
| Inverse diode | | | | |
| V_{RRM} | $T_j = 25^\circ\text{C}$ | 1700 | V | |
| I_F | $T_j = 175^\circ\text{C}$ | $T_c = 25^\circ\text{C}$ | 324 | A |
| | | $T_c = 80^\circ\text{C}$ | 238 | A |
| I_{Fnom} | | 300 | A | |
| I_{FRM} | $I_{FRM} = 2 \times I_{Fnom}$ | 600 | A | |
| I_{FSM} | $t_p = 10 \text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$ | 1710 | A | |
| T_j | | -40 ... 175 | $^\circ\text{C}$ | |
| Freewheeling diode | | | | |
| V_{RRM} | $T_j = 25^\circ\text{C}$ | 1700 | V | |
| I_F | | $T_c = 25^\circ\text{C}$ | 324 | A |
| | | $T_c = 80^\circ\text{C}$ | 238 | A |
| I_{Fnom} | | 300 | A | |
| I_{FRM} | $I_{FRM} = 2 \times I_{Fnom}$ | 600 | A | |
| I_{FSM} | $t_p = 10 \text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$ | 1710 | A | |
| T_j | | -40 ... 175 | $^\circ\text{C}$ | |
| Module | | | | |
| $I_{t(RMS)}$ | | 600 | A | |
| T_{stg} | | -40 ... 125 | $^\circ\text{C}$ | |
| V_{isol} | AC sinus 50Hz, t = 1 min | 4000 | V | |

| Characteristics | | | | | |
|-----------------|--|---------------------------|------|------|------------------|
| Symbol | Conditions | min. | typ. | max. | Unit |
| IGBT | | | | | |
| $V_{CE(sat)}$ | $I_C = 300 \text{ A}$ $V_{GE} = 15 \text{ V}$ chipelevel | $T_j = 25^\circ\text{C}$ | 1.90 | 2.20 | V |
| | | $T_j = 150^\circ\text{C}$ | 2.26 | 2.45 | V |
| V_{CE0} | chipelevel | $T_j = 25^\circ\text{C}$ | 1.1 | 1.2 | V |
| | | $T_j = 150^\circ\text{C}$ | 1 | 1.1 | V |
| r_{CE} | $V_{GE} = 15 \text{ V}$ chipelevel | $T_j = 25^\circ\text{C}$ | 2.7 | 3.3 | $\text{m}\Omega$ |
| | | $T_j = 150^\circ\text{C}$ | 4.2 | 4.5 | $\text{m}\Omega$ |
| $V_{GE(th)}$ | $V_{GE}=V_{CE}, I_C = 12 \text{ mA}$ | 5.2 | 5.8 | 6.4 | V |
| I_{CES} | $V_{GE} = 0 \text{ V}$ $V_{CE} = 1700 \text{ V}$ | $T_j = 25^\circ\text{C}$ | | 4 | mA |
| | | | | | mA |
| C_{ies} | $V_{CE} = 25 \text{ V}$ | | 24 | | nF |
| C_{oes} | $V_{GE} = 0 \text{ V}$ | | 1.00 | | nF |
| C_{res} | | | 0.76 | | nF |
| Q_G | $V_{GE} = -8 \text{ V...} + 15 \text{ V}$ | | 2400 | | nC |
| R_{Gint} | $T_j = 25^\circ\text{C}$ | | 2.50 | | Ω |

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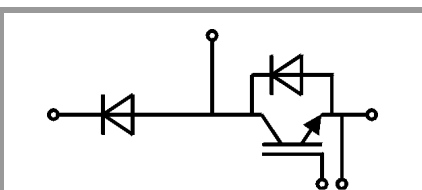
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GAL

| Characteristics | | | | | | |
|-----------------|--|---------------------------|------|------|-------|------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| IGBT | | | | | | |
| $t_{d(on)}$ | $V_{CC} = 1200 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 380 | | ns |
| t_r | $I_C = 300 \text{ A}$ | $T_j = 150^\circ\text{C}$ | | 50 | | ns |
| E_{on} | $V_{GE} = +15/-15 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 140 | | mJ |
| | $R_{Gon} = 3.3 \Omega$ | $T_j = 150^\circ\text{C}$ | | | | |
| $t_{d(off)}$ | $R_{Goff} = 3.3 \Omega$ | $T_j = 150^\circ\text{C}$ | | 840 | | ns |
| t_f | $di/dt_{on} = 6600 \text{ A}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 160 | | ns |
| | $di/dt_{off} = 1600 \text{ A}/\mu\text{s}$ | | | | | |
| E_{off} | $du/dt = 4400 \text{ V}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 122 | | mJ |
| | $L_s = 30 \text{ nH}$ | | | | | |
| $t_{d(on)}$ | $V_{CC} = 900 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 410 | | ns |
| t_r | $I_C = 300 \text{ A}$ | $T_j = 150^\circ\text{C}$ | | 90 | | ns |
| E_{on} | $V_{GE} = +15/-15 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 73 | | mJ |
| | $R_{Gon} = 3.3 \Omega$ | $T_j = 150^\circ\text{C}$ | | | | |
| $t_{d(off)}$ | $R_{Goff} = 3.3 \Omega$ | $T_j = 150^\circ\text{C}$ | | 780 | | ns |
| t_f | $di/dt_{on} = 3400 \text{ A}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 170 | | ns |
| | $di/dt_{off} = 1400 \text{ A}/\mu\text{s}$ | | | | | |
| E_{off} | $du/dt = 4400 \text{ V}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 100 | | mJ |
| | $L_s = 80 \text{ nH}$ | | | | | |
| $R_{th(j-c)}$ | per IGBT | | | | 0.083 | K/W |

| Characteristics | | | | | | |
|----------------------|--|---------------------------|------|------|-------|---------------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| Inverse diode | | | | | | |
| $V_F = V_{EC}$ | $I_F = 300 \text{ A}$ | $T_j = 25^\circ\text{C}$ | | 1.98 | 2.37 | V |
| | $V_{GE} = 0 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 2.11 | 2.52 | V |
| | chipllevel | | | | | |
| V_{F0} | | $T_j = 25^\circ\text{C}$ | 1.16 | 1.32 | 1.56 | V |
| | chipllevel | $T_j = 150^\circ\text{C}$ | | 1.08 | 1.22 | V |
| r_F | | $T_j = 25^\circ\text{C}$ | 1.7 | 2.2 | 2.7 | m Ω |
| | chipllevel | $T_j = 150^\circ\text{C}$ | | 3.4 | 4.3 | m Ω |
| I_{RRM} | $I_F = 300 \text{ A}$ | $T_j = 150^\circ\text{C}$ | | 310 | | A |
| Q_{rr} | $di/dt_{off} = 5600 \text{ A}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 103 | | μC |
| E_{rr} | $V_{GE} = -15 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 70 | | mJ |
| | $V_R = 1200 \text{ V}$ | | | | | |
| I_{RRM} | $I_F = 300 \text{ A}$ | $T_j = 150^\circ\text{C}$ | | 300 | | A |
| Q_{rr} | $di/dt_{off} = 3400 \text{ A}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 100 | | μC |
| E_{rr} | $V_{GE} = -15 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 61 | | mJ |
| | $V_R = 900 \text{ V}$ | | | | | |
| $R_{th(j-c)}$ | per diode | | | | 0.184 | K/W |

| Freewheeling diode | | | | | | |
|--------------------|--|---------------------------|------|------|-------|---------------|
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| $V_F = V_{EC}$ | $I_F = 300 \text{ A}$ | $T_j = 25^\circ\text{C}$ | | 1.98 | 2.37 | V |
| | $V_{GE} = 0 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 2.11 | 2.52 | V |
| | chipllevel | | | | | |
| V_{F0} | | $T_j = 25^\circ\text{C}$ | 1.16 | 1.32 | 1.56 | V |
| | chipllevel | $T_j = 150^\circ\text{C}$ | | 1.08 | 1.22 | V |
| r_F | | $T_j = 25^\circ\text{C}$ | 1.7 | 2.2 | 2.7 | m Ω |
| | chipllevel | $T_j = 150^\circ\text{C}$ | | 3.4 | 4.3 | m Ω |
| I_{RRM} | $I_F = 300 \text{ A}$ | $T_j = 150^\circ\text{C}$ | | 310 | | A |
| Q_{rr} | $di/dt_{off} = 5600 \text{ A}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 103 | | μC |
| E_{rr} | $V_{GE} = -15 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 70 | | mJ |
| | $V_R = 1200 \text{ V}$ | | | | | |
| I_{RRM} | $I_F = 300 \text{ A}$ | $T_j = 150^\circ\text{C}$ | | 300 | | A |
| Q_{rr} | $di/dt_{off} = 3400 \text{ A}/\mu\text{s}$ | $T_j = 150^\circ\text{C}$ | | 100 | | μC |
| E_{rr} | $V_{GE} = -15 \text{ V}$ | $T_j = 150^\circ\text{C}$ | | 61 | | mJ |
| | $V_R = 900 \text{ V}$ | | | | | |
| $R_{th(j-c)}$ | per diode | | | | 0.184 | K/W |

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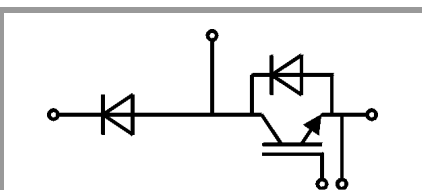
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| Characteristics | | | | | | |
|---------------------------|---|---------------------------|------|----------------|------|------------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| Module | | | | | | |
| L_{CE} | | | | 18 | | nH |
| $R_{CC'+EE'}$ | res. terminal-chip | $T_C = 25^\circ\text{C}$ | | 0.7 | | m Ω |
| | | $T_C = 125^\circ\text{C}$ | | 1 | | m Ω |
| $R_{th(c-s)}$ | per module | | | 0.045 | | K/W |
| M_s | to heat sink (M5) | | 3 | | 5 | Nm |
| M_t | | to terminals (M6) | 2.5 | | 5 | Nm |
| | | | | | | Nm |
| w | | | | | 250 | g |
| Temperature Sensor | | | | | | |
| R_{100} | $T_C=100^\circ\text{C}$ ($R_{25}=5 \text{ k}\Omega$) | | | $493 \pm 5\%$ | | Ω |
| $B_{100/125}$ | $R_{(T)}=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$; T[K]; | | | $3550 \pm 2\%$ | | K |



GAL

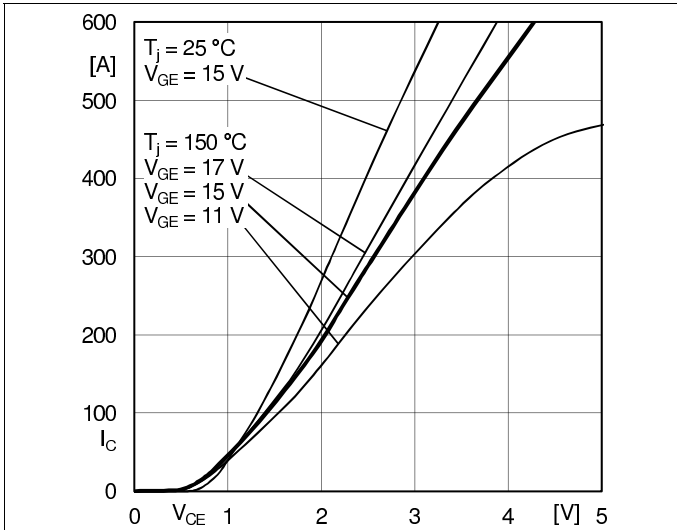


Fig. 1: Typ. output characteristic, inclusive R_{CC+EE}

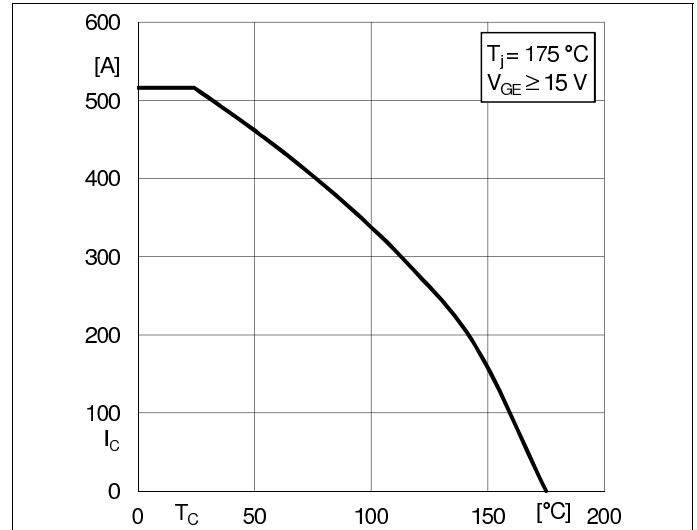


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

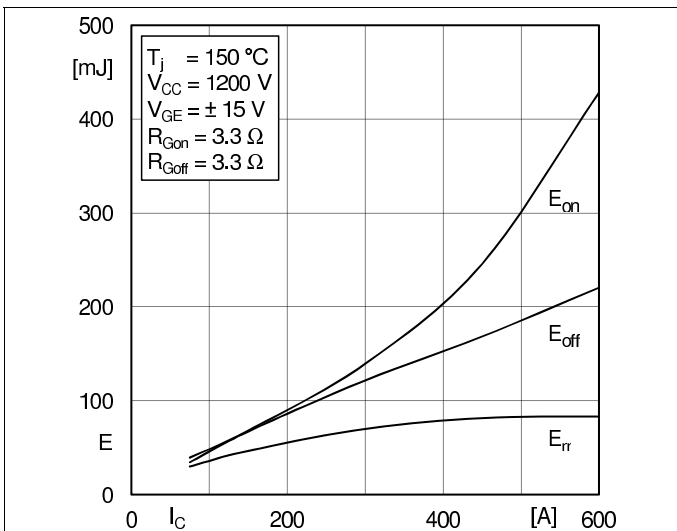


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

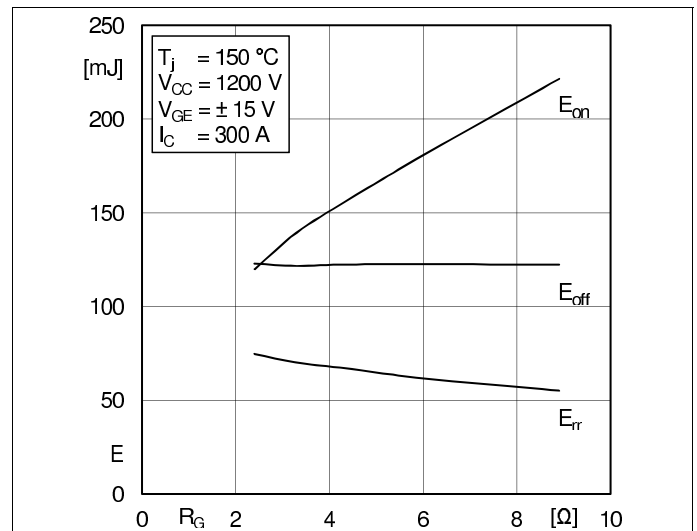


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

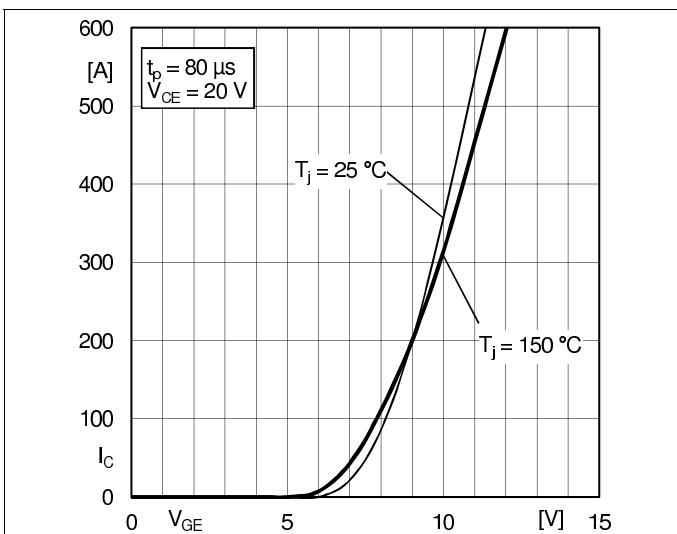


Fig. 5: Typ. transfer characteristic

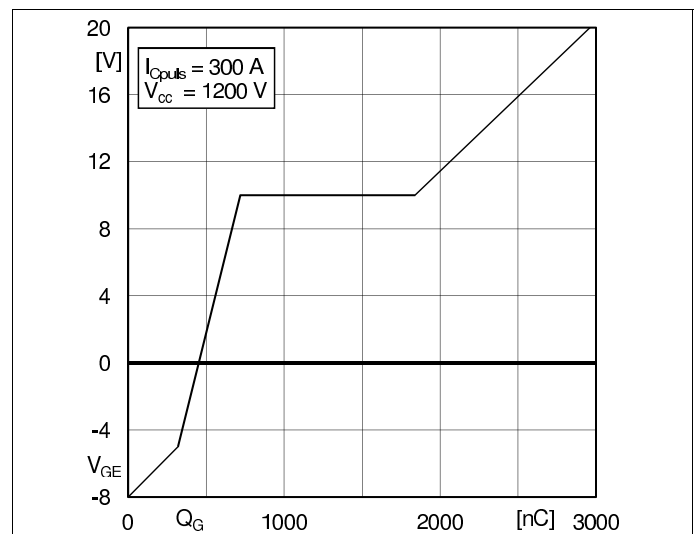


Fig. 6: Typ. gate charge characteristic

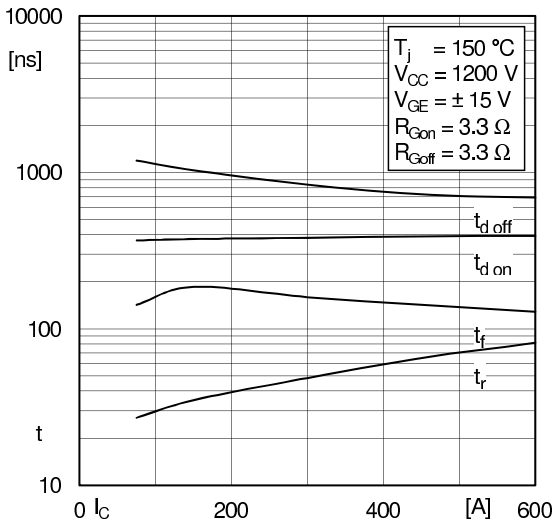


Fig. 7: Typ. switching times vs. I_C

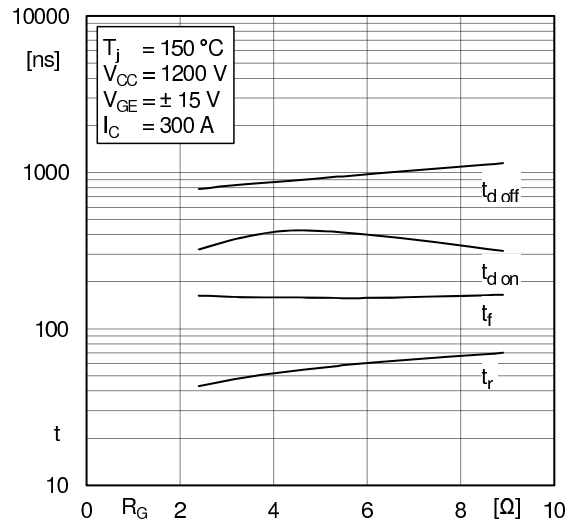


Fig. 8: Typ. switching times vs. gate resistor R_G

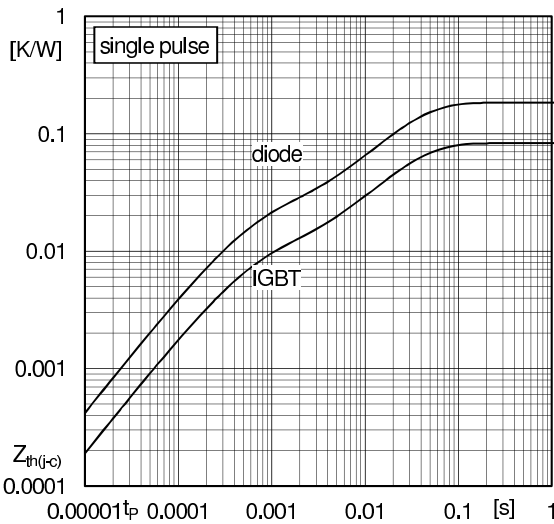


Fig. 9: Typ. transient thermal impedance

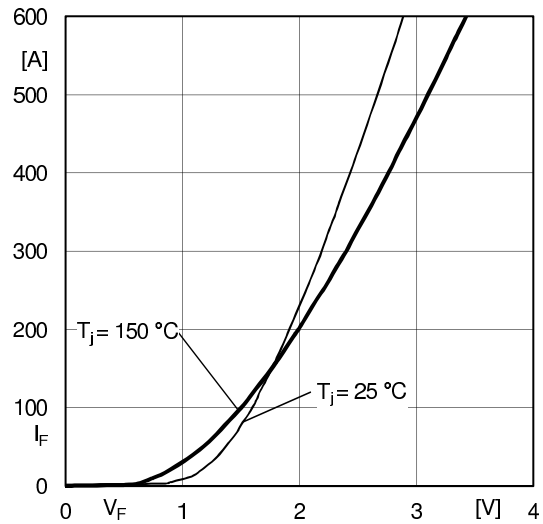


Fig. 10: Typ. CAL diode forward charact., incl. R_{CC+EE}

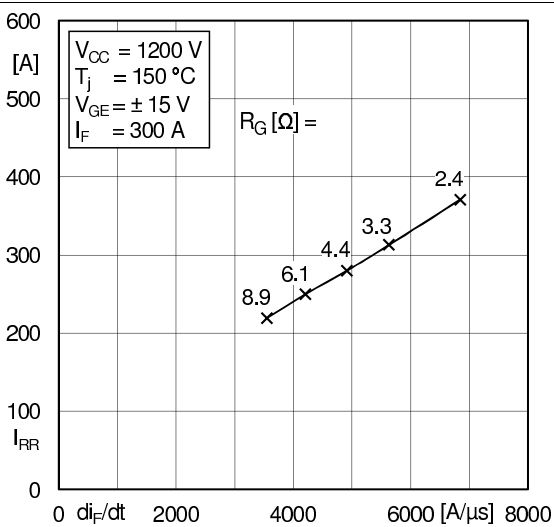


Fig. 11: Typ. CAL diode peak reverse recovery current

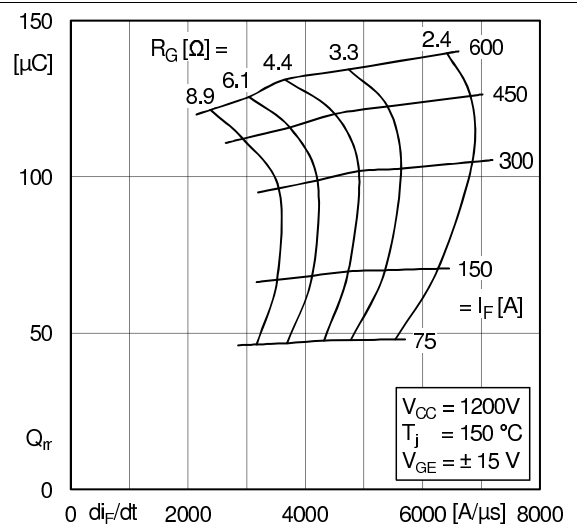
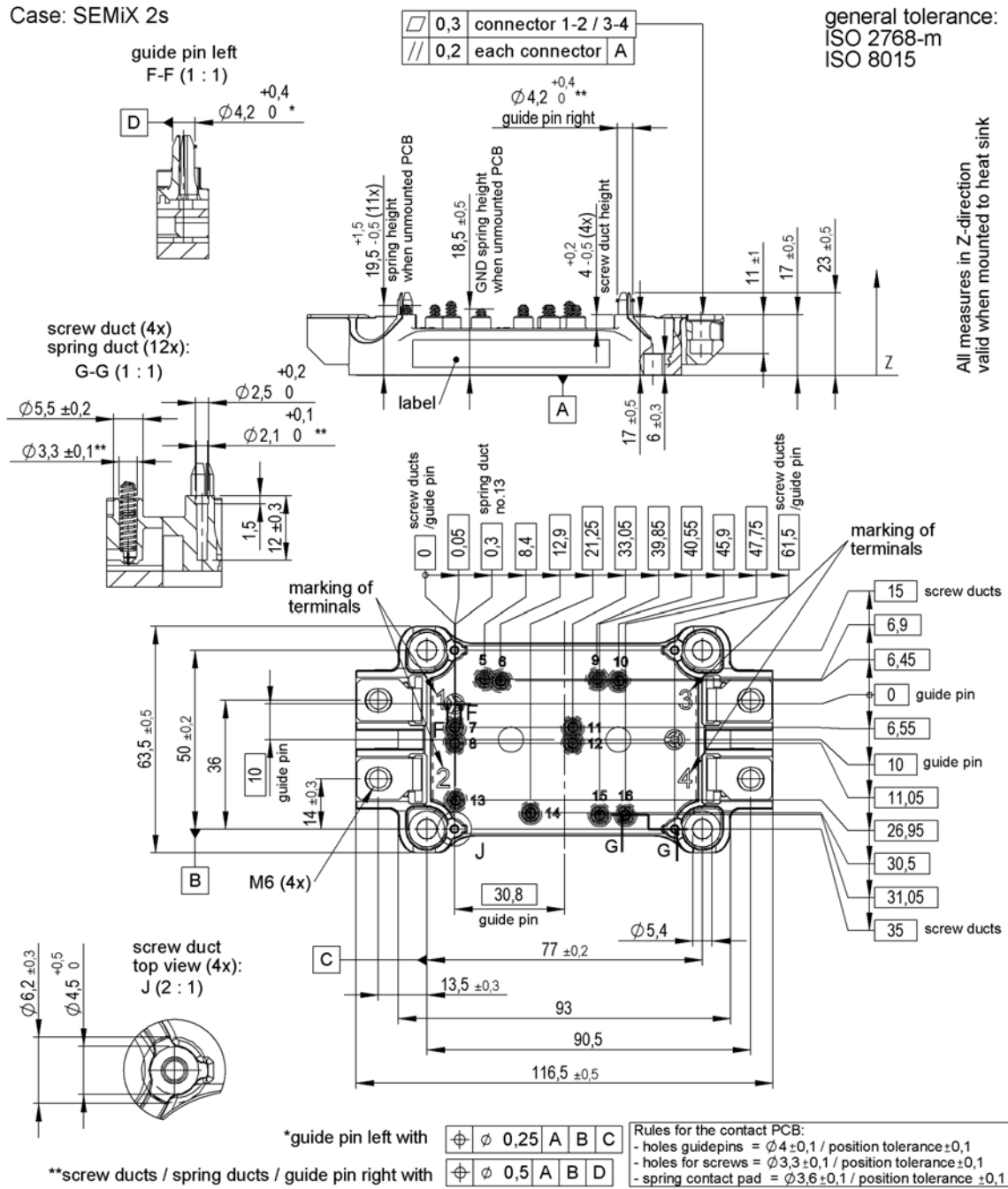


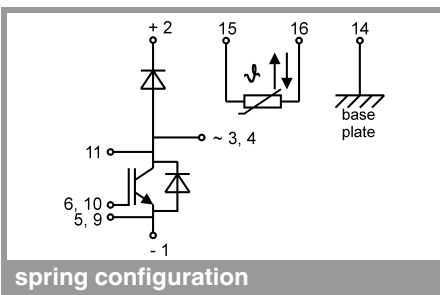
Fig. 12: Typ. CAL diode recovery charge

SEMiX302GAL17E4s

Case: SEMiX 2s



SEMiX 2s



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.